

**IN THE SPECIFICATION**

Please amend the first paragraph on page 19 of the specification as follows:

All the discharging nozzles 81a to 81c are arranged out of a wafers' "upside" area projected upwardly in plan view and also arranged in an "upper" area of the wafers in the horizontal position. The former positioning of the nozzles 81a to 81c outside the wafers' "upside" area means that the nozzles 81a to 81c are so positioned that even if being lowered vertically, they would not interfere with the wafers W. Further, the latter positioning of the nozzles 81a to ~~81b~~ 81c inside the "upper" area of the wafers in the horizontal position means that the nozzles 81a to ~~81b~~ 81c are positioned above a horizontal plane (shown with a two-dotted line of Fig. 11) passing through the centers of the wafers W being held in a designated position in the chamber 82.